

INVITATION FOR BIDS

Kingdom of Cambodia

Trade Development Support Program (TDSP)

Grant No.: TF093573

Procurement of Laboratory Equipment and Mobile Testing Kits

(IFB No.: TDSP/2014/127)

1. The Royal Government of Cambodia (RGC) has received a grant from the International Development Association toward the cost of Trade Development Support Program, and it intends to apply part of the proceeds of this grant to payments under the Contract for the **Procurement of Laboratory Equipment and Mobile Testing Kits (Ref: TDSP/2014/127)**.
2. The Department of International Cooperation (D/ICO) now invites sealed bids from eligible and qualified bidders for:

Lot 1: Laboratory Equipment

Lot 2: Mobile Testing Kits

Bidders may bid one or both Lots. Bidders must offer bids for all items in the Lot. Bid evaluation and contract award will be Lot-wise.

3. Procurement will be conducted through National Competitive Bidding Procedures outlined in the Procurement Manual for Externally Financed/Programs, and under the laws and regulations governing public procurement with the Kingdom of Cambodia.
4. This invitation is open to all bidders from all areas.
5. Interested eligible bidders may obtain further information from and inspect the Bidding Documents at the address given below from 8:30 am to 5:00pm.
6. Qualification requirements include: The Bidder shall furnish documentary evidence that it meets the following experience and financial requirements: (i) that the Bidder has satisfactorily completed at least one contract for supply of similar goods in the preceding three years of not less than 50% of the bid price. (ii) that the Manufacturer of the offered goods, if a different entity from the Bidder, has experience of at least 3 years in the manufacturing of similar goods. (iii) that the Bidder has availability of liquid assets through either: access to a line of credit or cash in bank account of an amount at least 50% of the bid price, net of other contractual commitments; or credit terms with vendors specifically for the goods to be supplied under the contract, and valid for at least 6 months after the deadline date for submission of bids specified in ITB Clause 21. (iv) authority to seek references from the Bidder's bankers.
7. A complete set of Bidding Documents in English may be purchased by interested bidders on the submission of a written Application to the address given below and upon payment of a non-refundable fee **Thirty Three and forty cents (33.4) US Dollars**. The method of payment will be in cash. Other than payment of the non-refundable fee specified above, there shall be no other conditions for purchase of the bidding documents.

8. In case of any difficulty in purchase of the bidding documents, interested parties may contact in writing to *Mr. CHHIENG Pich, TDSP Project Director, Ministry of Commerce, Russian Federation Blvd., Sangkat Toek Thla, Khan Sen Sok, Phnom Penh, Cambodia, Tel: 023 866 064, Email: chhieng_pich@hotmail.com* and also send a copy of the communication to the *Department of Public Procurement (DPP) in the Ministry of Finance, Street 92, Sangkat Wat Phnom, Khan Daun Penh, Phnom Penh, Cambodia.*
9. Bids must be delivered to the address given below at or before **3.00 PM on 1st August 2014**. Late bids will be rejected. Bids will be opened in the presence of the Bidders' representatives and the project's beneficiaries from the concerned local community who choose to attend shall be allowed to be present in person at the address given below at **3.00 PM on 1st August 2014**.
10. All bids shall be accompanied by a by a Bid Securing Declaration as described in the Instructions to Bidders
11. The Government of Cambodia and/or the Funding Agency will declare a firm ineligible either indefinitely or for a stated period of time, to be financed by the Government of Cambodia and/or the Funding Agency respectively, if it at any time determines that the firm has engaged in corrupt or fraudulent, coercive or collusive practices in competing for or in executing a contract.
12. The address referred to above is:

Procurement Unit

Department of International Cooperation (DICO)

Trade Development Support Program (TDSP)

1st Floor, Ministry of Commerce, Russian Federation Blvd., Phum Toek Thla, Sangkat Toek Thla,
Khan Sen Sok, Phnom Penh, Cambodia.

Tel: 023 866 064

*E-mail: hongbunseng@gmail.com cc: chhiengpich@gmail.com,
sereyroath.ek@gmail.com, vannarithd@gmail.com*